

# MUN5211DW1T1 Series

Preferred Devices

## Dual Bias Resistor Transistors

### NPN Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the MUN5211DW1T1 series, two BRT devices are housed in the SOT-363 package which is ideal for low power surface mount applications where board space is at a premium.

#### Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Pb-Free Packages are Available

#### MAXIMUM RATINGS

( $T_A = 25^\circ\text{C}$  unless otherwise noted, common for  $Q_1$  and  $Q_2$ )

Rating	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	50	Vdc
Collector-Emitter Voltage	$V_{CEO}$	50	Vdc
Collector Current	$I_C$	100	mAdc

#### THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	187 (Note 1) 256 (Note 2) 1.5 (Note 1) 2.0 (Note 2)	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	670 (Note 1) 490 (Note 2)	$^\circ\text{C/W}$
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	250 (Note 1) 385 (Note 2) 2.0 (Note 1) 3.0 (Note 2)	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	493 (Note 1) 325 (Note 2)	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Lead	$R_{\theta JL}$	188 (Note 1) 208 (Note 2)	$^\circ\text{C/W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

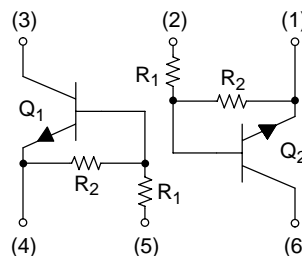
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad
2. FR-4 @ 1.0 x 1.0 inch Pad



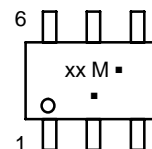
ON Semiconductor®

<http://onsemi.com>



SOT-363  
CASE 419B  
STYLE 1

#### MARKING DIAGRAM



- xx = Device Code
- M = Date Code\*
- = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

#### DEVICE MARKING INFORMATION

See specific marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

## MUN5211DW1T1 Series

### DEVICE MARKING AND RESISTOR VALUES

Device	Package	Marking	R1 (K)	R2 (K)	Shipping†
MUN5211DW1T1	SOT-363	7A	10	10	3000/Tape & Reel
MUN5211DW1T1G	SOT-363 (Pb-Free)	7A	10	10	3000/Tape & Reel
MUN5212DW1T1	SOT-363	7B	22	22	3000/Tape & Reel
MUN5212DW1T1G	SOT-363 (Pb-Free)	7B	22	22	3000/Tape & Reel
MUN5213DW1T1	SOT-363	7C	47	47	3000/Tape & Reel
MUN5213DW1T1G	SOT-363 (Pb-Free)	7C	47	47	3000/Tape & Reel
MUN5214DW1T1	SOT-363	7D	10	47	3000/Tape & Reel
MUN5214DW1T1G	SOT-363 (Pb-Free)	7D	10	47	3000/Tape & Reel
MUN5215DW1T1	SOT-363	7E	10	∞	3000/Tape & Reel
MUN5215DW1T1G	SOT-363 (Pb-Free)	7E	10	∞	3000/Tape & Reel
MUN5216DW1T1	SOT-363	7F	4.7	∞	3000/Tape & Reel
MUN5216DW1T1G	SOT-363 (Pb-Free)	7F	4.7	∞	3000/Tape & Reel
MUN5230DW1T1	SOT-363	7G	1.0	1.0	3000/Tape & Reel
MUN5230DW1T1G	SOT-363 (Pb-Free)	7G	1.0	1.0	3000/Tape & Reel
MUN5231DW1T1	SOT-363	7H	2.2	2.2	3000/Tape & Reel
MUN5231DW1T1G	SOT-363 (Pb-Free)	7H	2.2	2.2	3000/Tape & Reel
MUN5232DW1T1	SOT-363	7J	4.7	4.7	3000/Tape & Reel
MUN5232DW1T1G	SOT-363 (Pb-Free)	7J	4.7	4.7	3000/Tape & Reel
MUN5233DW1T1	SOT-363	7K	4.7	47	3000/Tape & Reel
MUN5233DW1T1G	SOT-363 (Pb-Free)	7K	4.7	47	3000/Tape & Reel
MUN5234DW1T1	SOT-363	7L	22	47	3000/Tape & Reel
MUN5234DW1T1G	SOT-363 (Pb-Free)	7L	22	47	3000/Tape & Reel
MUN5235DW1T1	SOT-363	7M	2.2	47	3000/Tape & Reel
MUN5235DW1T1G	SOT-363 (Pb-Free)	7M	2.2	47	3000/Tape & Reel
MUN5236DW1T1	SOT-363	7N	100	100	3000/Tape & Reel
MUN5236DW1T1G	SOT-363 (Pb-Free)	7N	100	100	3000/Tape & Reel
MUN5237DW1T1	SOT-363	7P	47	22	3000/Tape & Reel
MUN5237DW1T1G	SOT-363 (Pb-Free)	7P	47	22	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MUN5211DW1T1 Series

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted, common for $Q_1$ and $Q_2$ )

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Base Cutoff Current ( $V_{CB} = 50\text{ V}$ , $I_E = 0$ )	$I_{CBO}$	-	-	100	nAdc
Collector-Emitter Cutoff Current ( $V_{CE} = 50\text{ V}$ , $I_B = 0$ )	$I_{CEO}$	-	-	500	nAdc
Emitter-Base Cutoff Current ( $V_{EB} = 6.0\text{ V}$ , $I_C = 0$ )	$I_{EBO}$	-	-	0.5	mAdc
MUN5211DW1T1, G		-	-	0.2	
MUN5212DW1T1, G		-	-	0.1	
MUN5213DW1T1, G		-	-	0.2	
MUN5214DW1T1, G		-	-	0.9	
MUN5215DW1T1, G		-	-	1.9	
MUN5216DW1T1, G		-	-	4.3	
MUN5230DW1T1, G		-	-	2.3	
MUN5231DW1T1, G		-	-	1.5	
MUN5232DW1T1, G		-	-	0.18	
MUN5233DW1T1, G		-	-	0.13	
MUN5234DW1T1, G		-	-	0.2	
MUN5235DW1T1, G		-	-	0.05	
MUN5236DW1T1, G		-	-	0.13	
MUN5237DW1T1, G		-	-		
Collector-Base Breakdown Voltage ( $I_C = 10\ \mu\text{A}$ , $I_E = 0$ )	$V_{(BR)CBO}$	50	-	-	Vdc
Collector-Emitter Breakdown Voltage (Note 3) ( $I_C = 2.0\text{ mA}$ , $I_B = 0$ )	$V_{(BR)CEO}$	50	-	-	Vdc

3. Pulse Test: Pulse Width < 300  $\mu\text{s}$ , Duty Cycle < 2.0%

### ON CHARACTERISTICS (Note 4)

DC Current Gain ( $V_{CE} = 10\text{ V}$ , $I_C = 5.0\text{ mA}$ )	$h_{FE}$	35	60	-	
MUN5211DW1T1, G		60	100	-	
MUN5212DW1T1, G		80	140	-	
MUN5213DW1T1, G		80	140	-	
MUN5214DW1T1, G		160	350	-	
MUN5215DW1T1, G		160	350	-	
MUN5216DW1T1, G		3.0	5.0	-	
MUN5230DW1T1, G		8.0	15	-	
MUN5231DW1T1, G		15	30	-	
MUN5232DW1T1, G		80	200	-	
MUN5233DW1T1, G		80	150	-	
MUN5234DW1T1, G		80	140	-	
MUN5235DW1T1, G		80	150	-	
MUN5236DW1T1, G		80	140	-	
MUN5237DW1T1, G		80	140	-	

## MUN5211DW1T1 Series

<b>Collector-Emitter Saturation Voltage</b> <i>I<sub>C</sub></i> = 10 mA, <i>I<sub>B</sub></i> = 0.3 mA  <i>I<sub>C</sub></i> = 10 mA, <i>I<sub>B</sub></i> = 5 mA  <i>I<sub>C</sub></i> = 10 mA, <i>I<sub>B</sub></i> = 1 mA	MUN5211DW1T1, G	<i>V<sub>CE(sat)</sub></i>	-	-	0.25	Vdc
	MUN5212DW1T1, G		-	-	0.25	
	MUN5213DW1T1, G		-	-	0.25	
	MUN5214DW1T1, G		-	-	0.25	
	MUN5235DW1T1, G		-	-	0.25	
	MUN5236DW1T1, G		-	-	0.25	
	MUN5230DW1T1, G		-	-	0.25	
	MUN5231DW1T1, G		-	-	0.25	
	MUN5237DW1T1, G		-	-	0.25	
	MUN5215DW1T1, G		-	-	0.25	
	MUN5216DW1T1, G		-	-	0.25	
	MUN5232DW1T1, G		-	-	0.25	
	MUN5233DW1T1, G		-	-	0.25	
	MUN5234DW1T1, G		-	-	0.25	
<b>Output Voltage (on)</b> <i>V<sub>CC</sub></i> = 5.0 V, <i>V<sub>B</sub></i> = 2.5 V, <i>R<sub>L</sub></i> = 1.0 kΩ   <i>V<sub>CC</sub></i> = 5.0 V, <i>V<sub>B</sub></i> = 3.5 V, <i>R<sub>L</sub></i> = 1.0 kΩ <i>V<sub>CC</sub></i> = 5.0 V, <i>V<sub>B</sub></i> = 5.5 V, <i>R<sub>L</sub></i> = 1.0 kΩ <i>V<sub>CC</sub></i> = 5.0 V, <i>V<sub>B</sub></i> = 4.0 V, <i>R<sub>L</sub></i> = 1.0 kΩ	MUN5211DW1T1, G	<i>V<sub>OL</sub></i>	-	-	0.2	Vdc
	MUN5212DW1T1, G		-	-	0.2	
	MUN5214DW1T1, G		-	-	0.2	
	MUN5215DW1T1, G		-	-	0.2	
	MUN5216DW1T1, G		-	-	0.2	
	MUN5230DW1T1, G		-	-	0.2	
	MUN5231DW1T1, G		-	-	0.2	
	MUN5232DW1T1, G		-	-	0.2	
	MUN5233DW1T1, G		-	-	0.2	
	MUN5234DW1T1, G		-	-	0.2	
	MUN5235DW1T1, G		-	-	0.2	
	MUN5213DW1T1, G		-	-	0.2	
	MUN5236DW1T1, G		-	-	0.2	
	MUN5237DW1T1, G		-	-	0.2	

4. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

# MUN5211DW1T1 Series

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted, common for Q<sub>1</sub> and Q<sub>2</sub>) (Continued)

Characteristic	Symbol	Min	Typ	Max	Unit	
<b>ON CHARACTERISTICS</b> (Note 5) (Continued)						
Output Voltage (off) (V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 0.5 V, R <sub>L</sub> = 1.0 kΩ)	MUN5211DW1T1, G MUN5212DW1T1, G MUN5213DW1T1, G MUN5214DW1T1, G MUN5233DW1T1, G MUN5234DW1T1, G MUN5235DW1T1, G	V <sub>OH</sub>	4.9	–	–	Vdc
(V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 0.050 V, R <sub>L</sub> = 1.0 kΩ)	MUN5230DW1T1, G		4.9	–	–	
(V <sub>CC</sub> = 5.0 V, V <sub>B</sub> = 0.25 V, R <sub>L</sub> = 1.0 kΩ)	MUN5215DW1T1, G MUN5216DW1T1, G MUN5231DW1T1, G MUN5232DW1T1, G MUN5236DW1T1, G MUN5237DW1T1, G		4.9	–	–	
Input Resistor	MUN5211DW1T1, G MUN5212DW1T1, G MUN5213DW1T1, G MUN5214DW1T1, G MUN5215DW1T1, G MUN5216DW1T1, G MUN5230DW1T1, G MUN5231DW1T1, G MUN5232DW1T1, G MUN5233DW1T1, G MUN5234DW1T1, G MUN5235DW1T1, G MUN5236DW1T1, G MUN5237DW1T1, G	R1	7.0 15.4 32.9 7.0 7.0 3.3 0.7 1.5 3.3 3.3 15.4 1.54 70 32.9	10 22 47 10 10 4.7 1.0 2.2 4.7 4.7 22 2.2 100 47	13 28.6 61.1 13 13 6.1 1.3 2.9 6.1 6.1 28.6 2.86 130 61.1	k Ω
Resistor Ratio	MUN5211DW1T1, G/MUN5212DW1T1, G/ MUN5213DW1T1, G/MUN5236DW1T1, G MUN5214DW1T1, G MUN5215DW1T1, G/MUN5216DW1T1, G MUN5230DW1T1, G/MUN5231DW1T1, G/MUN5232DW1T1, G MUN5233DW1T1, G MUN5234DW1T1, G MUN5235DW1T1, G MUN5237DW1T1, G	R1/R2	0.8 0.17 – 0.8 0.055 0.38 0.038 1.7	1.0 0.21 – 1.0 0.1 0.47 0.047 2.1	1.2 0.25 – 1.2 0.185 0.56 0.056 2.6	

5. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

### ALL MUN5211DW1T1 SERIES DEVICES

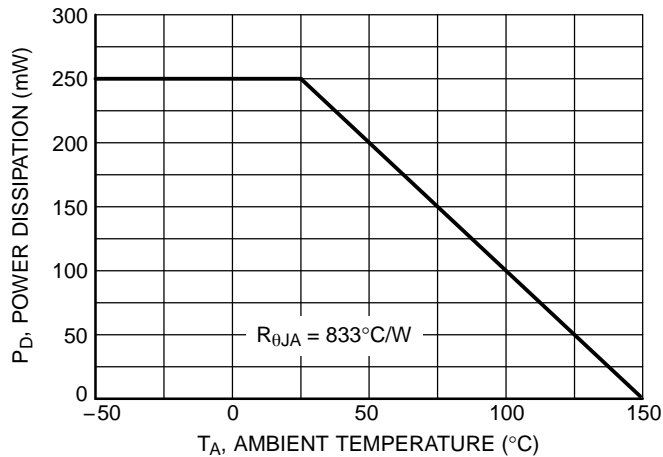


Figure 1. Derating Curve

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5211DW1T1

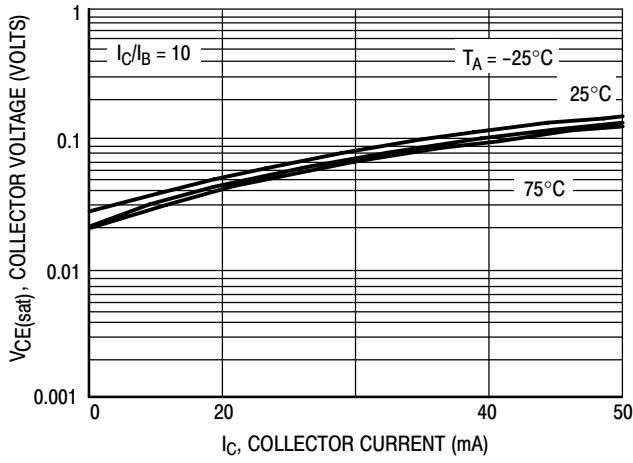


Figure 2.  $V_{CE(sat)}$  versus  $I_C$

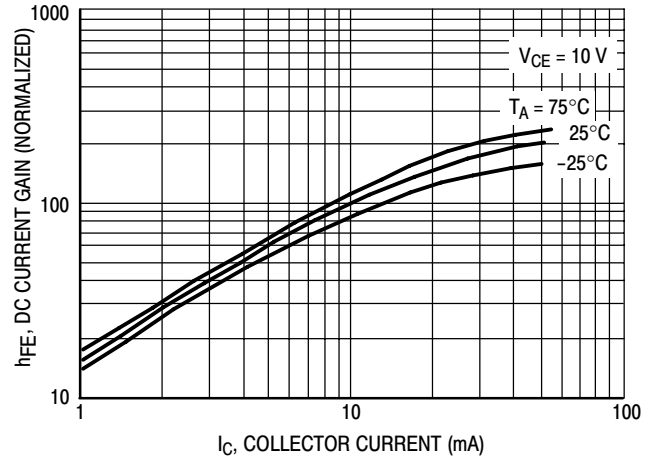


Figure 3. DC Current Gain

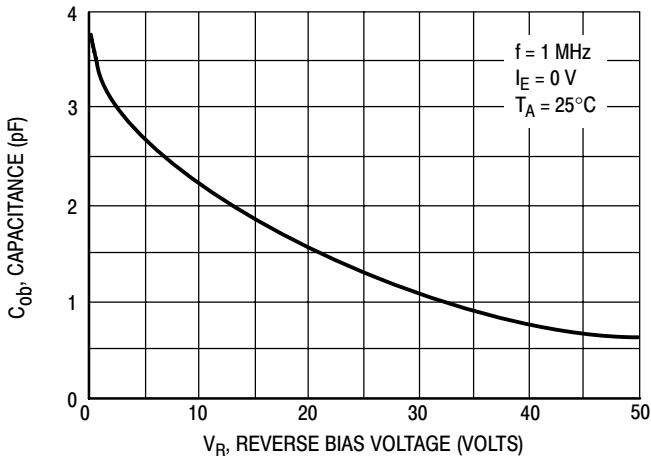


Figure 4. Output Capacitance

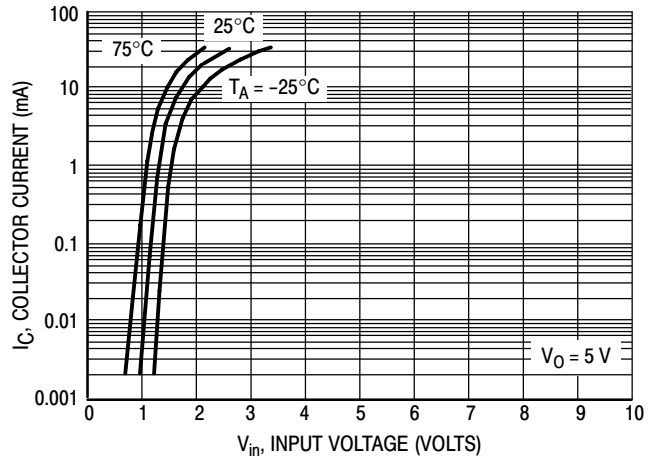


Figure 5. Output Current versus Input Voltage

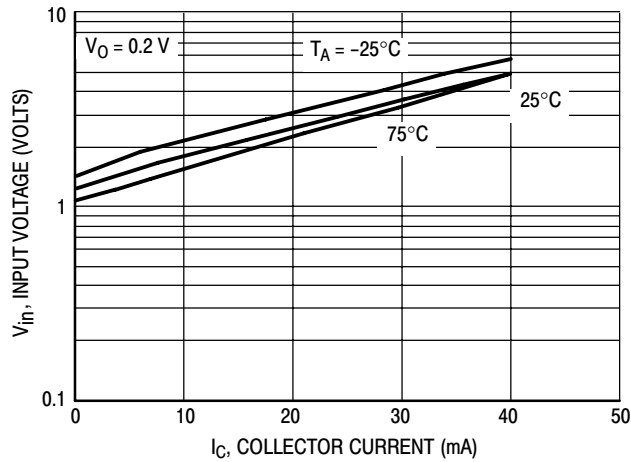


Figure 6. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5212DW1T1

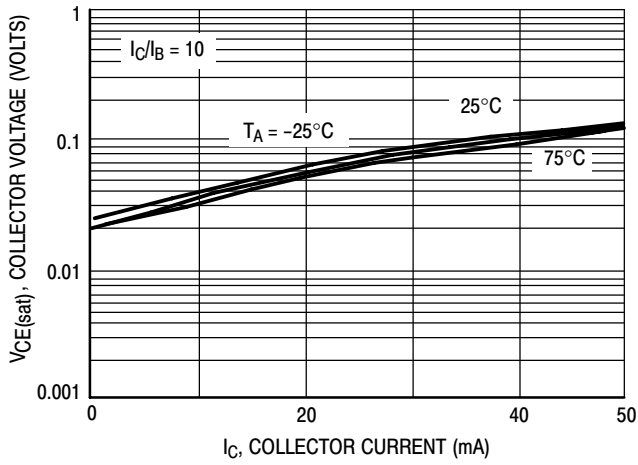


Figure 7.  $V_{CE(sat)}$  versus  $I_C$

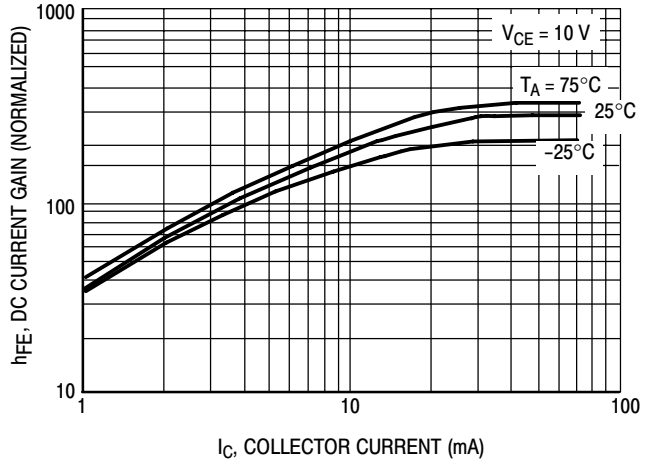


Figure 8. DC Current Gain

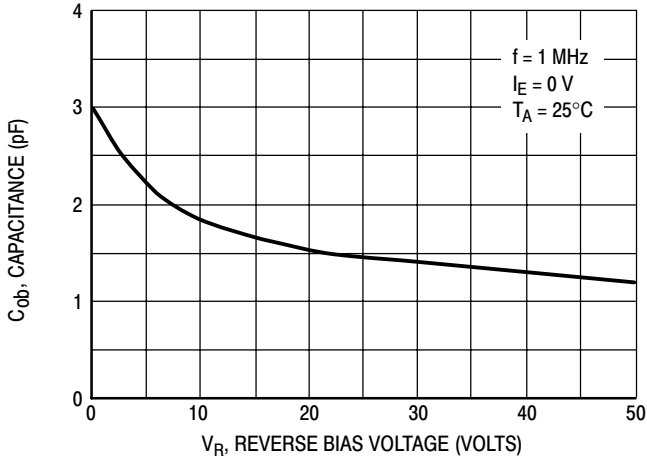


Figure 9. Output Capacitance

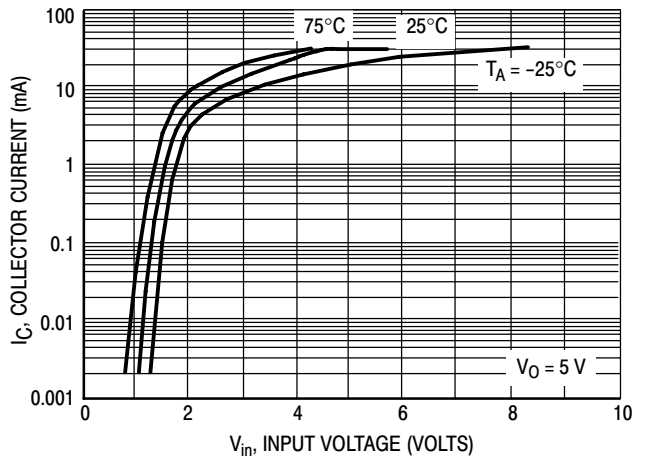


Figure 10. Output Current versus Input Voltage

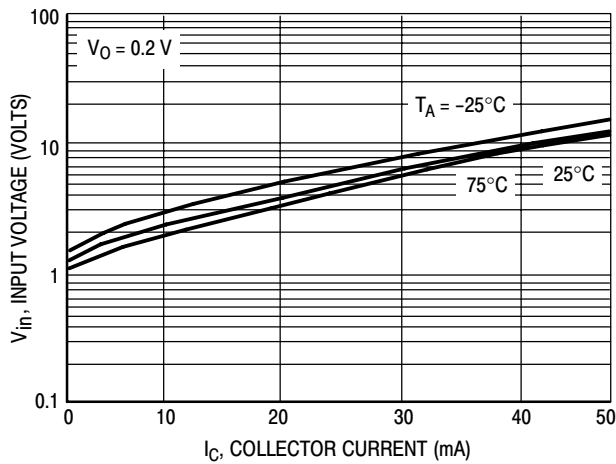


Figure 11. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5213DW1T1

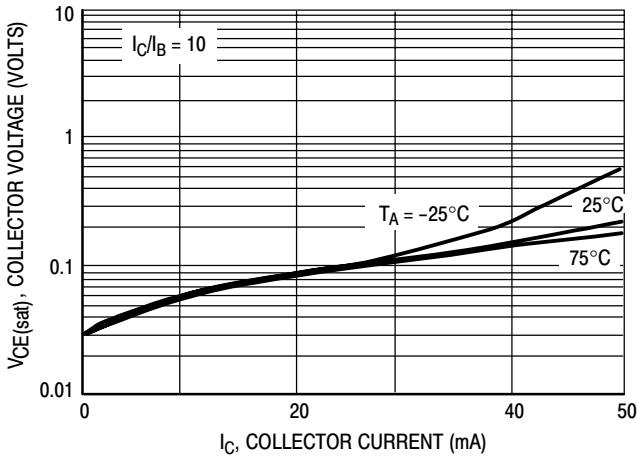


Figure 12.  $V_{CE(sat)}$  versus  $I_C$

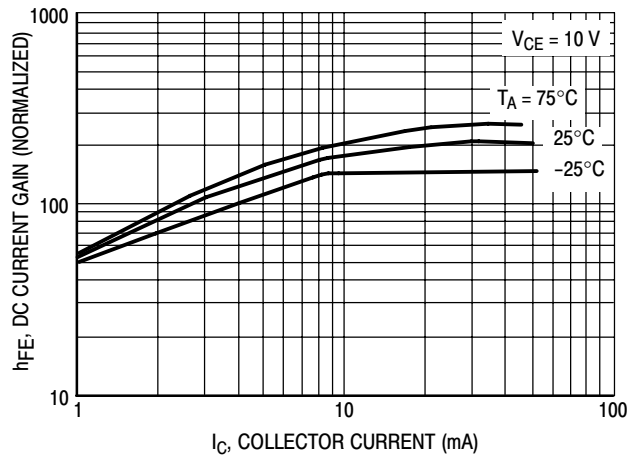


Figure 13. DC Current Gain

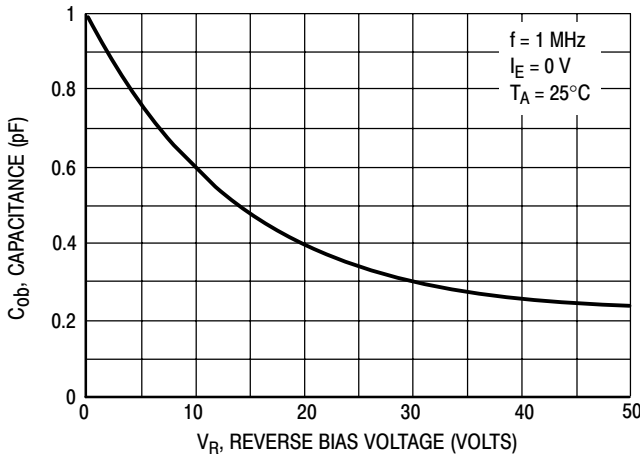


Figure 14. Output Capacitance

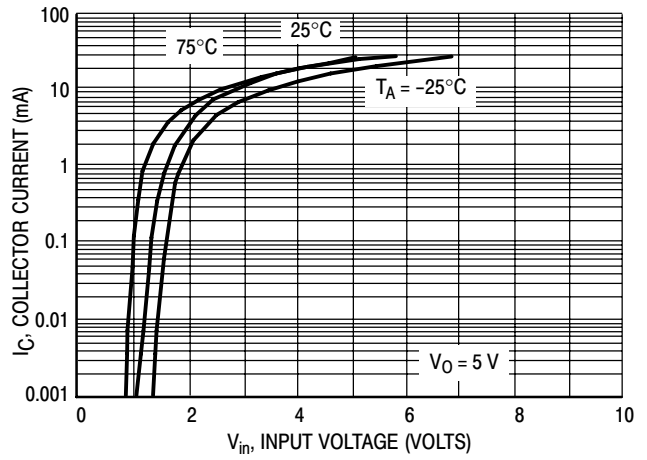


Figure 15. Output Current versus Input Voltage

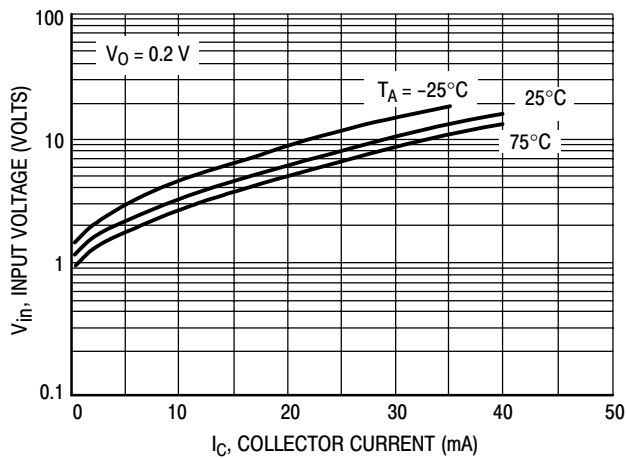


Figure 16. Input Voltage versus Output Current



# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5214DW1T1

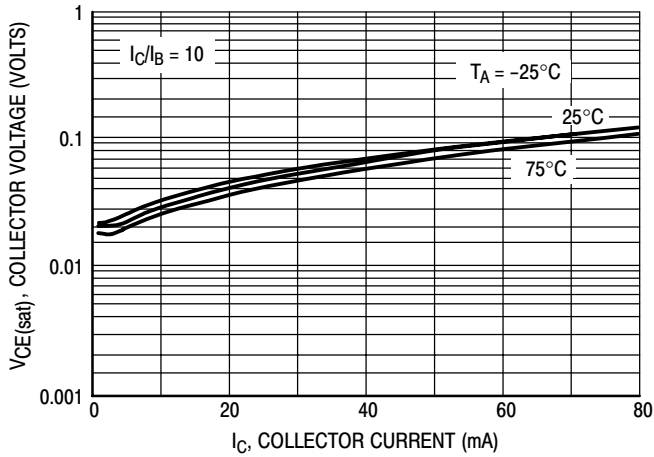


Figure 17.  $V_{CE(sat)}$  versus  $I_C$

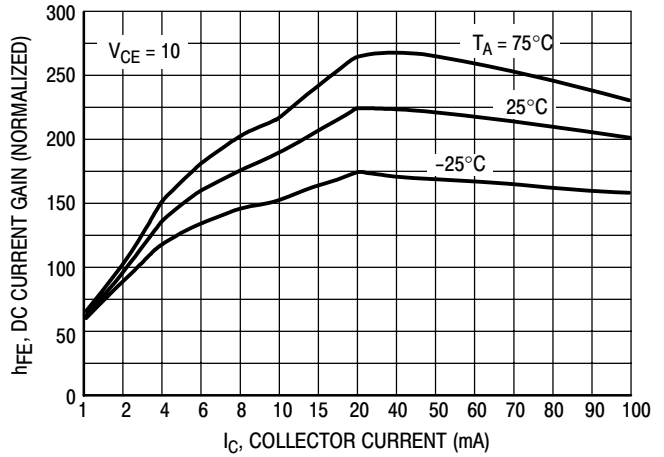


Figure 18. DC Current Gain

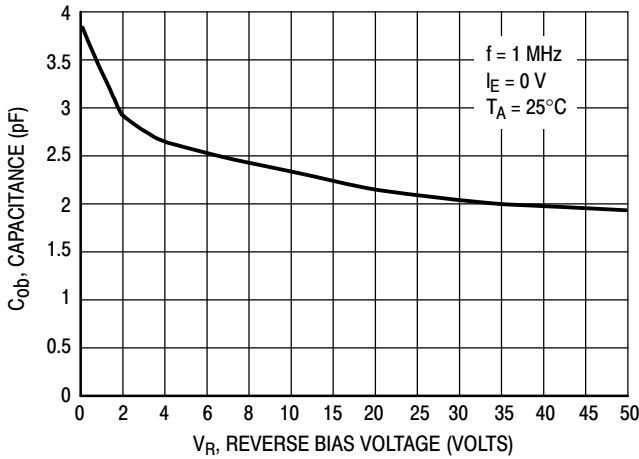


Figure 19. Output Capacitance

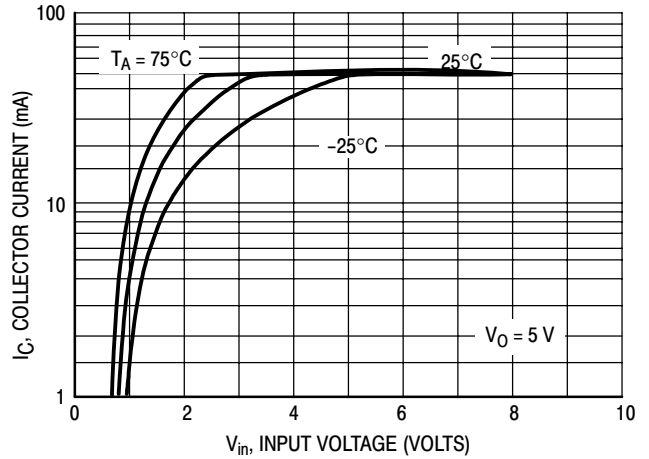


Figure 20. Output Current versus Input Voltage

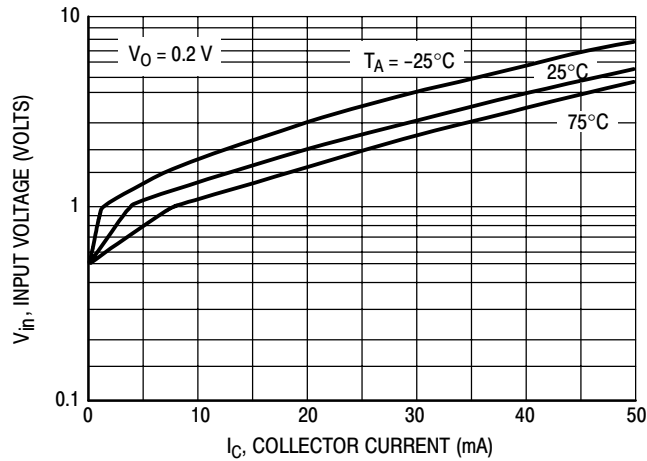


Figure 21. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5215DW1T1

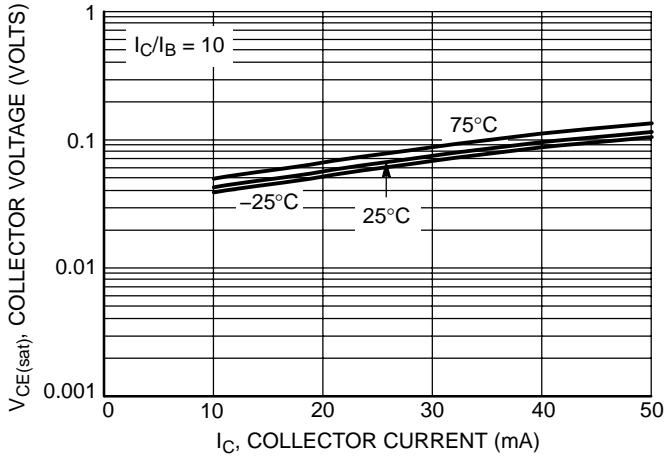


Figure 22.  $V_{CE(sat)}$  versus  $I_C$

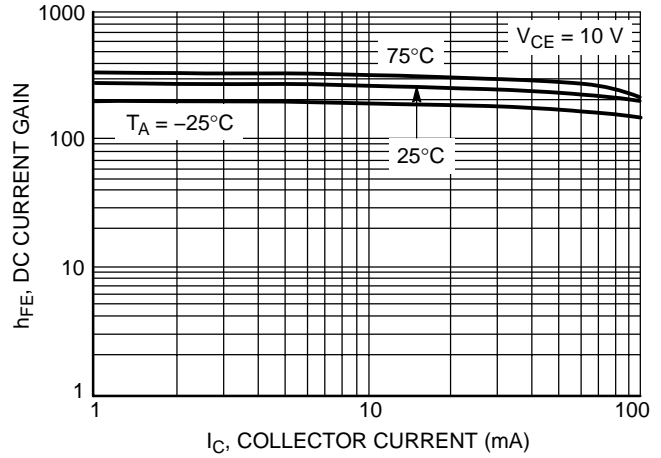


Figure 23. DC Current Gain

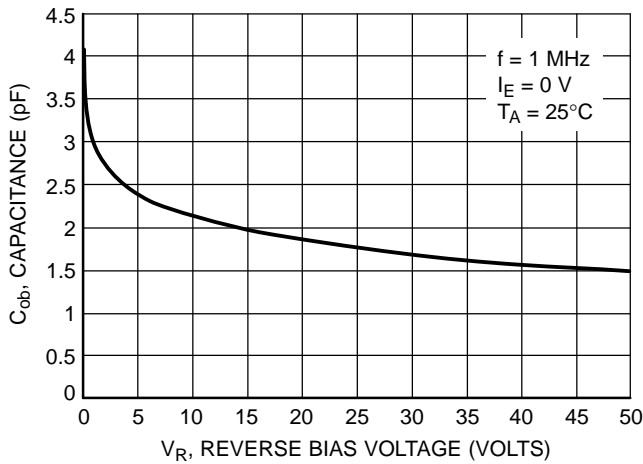


Figure 24. Output Capacitance

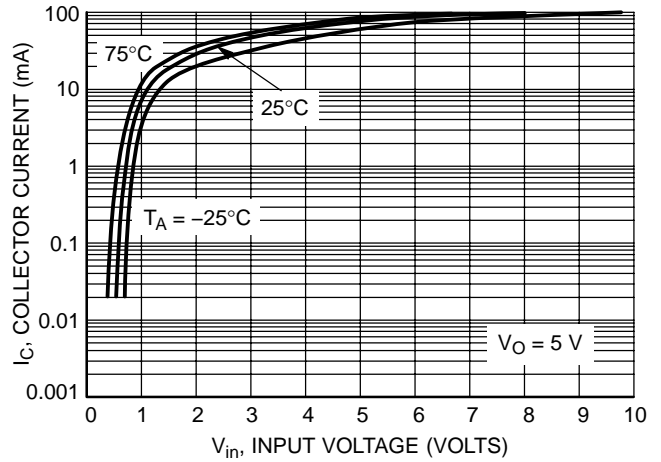


Figure 25. Output Current versus Input Voltage

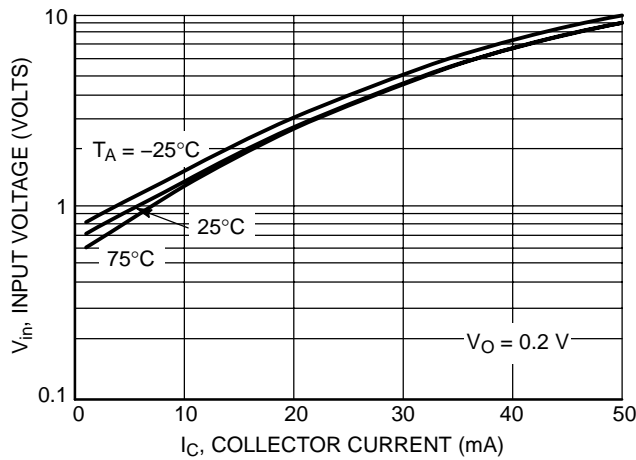


Figure 26. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5216DW1T1

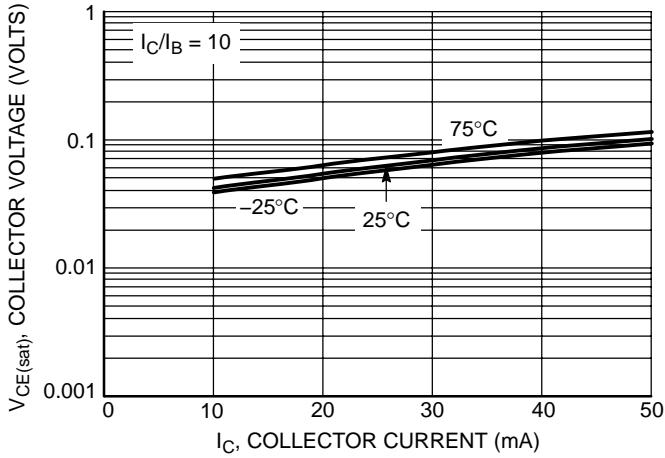


Figure 27.  $V_{CE(sat)}$  versus  $I_C$

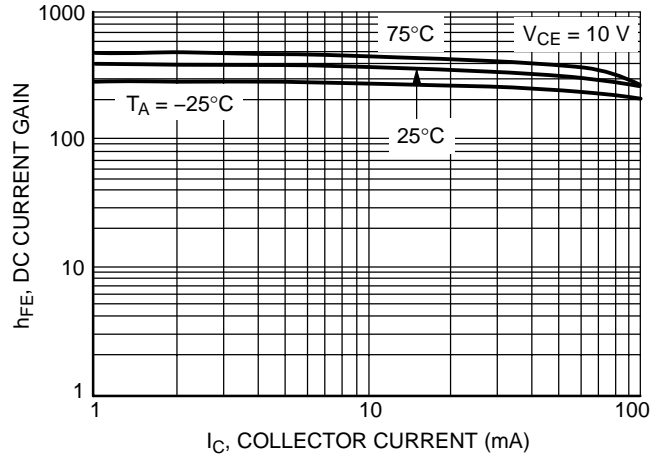


Figure 28. DC Current Gain

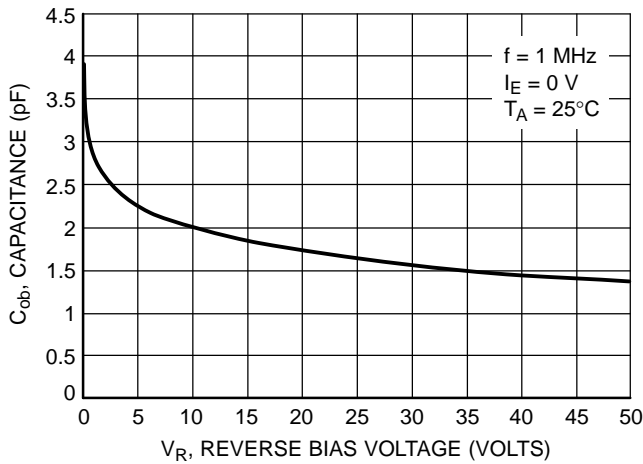


Figure 29. Output Capacitance

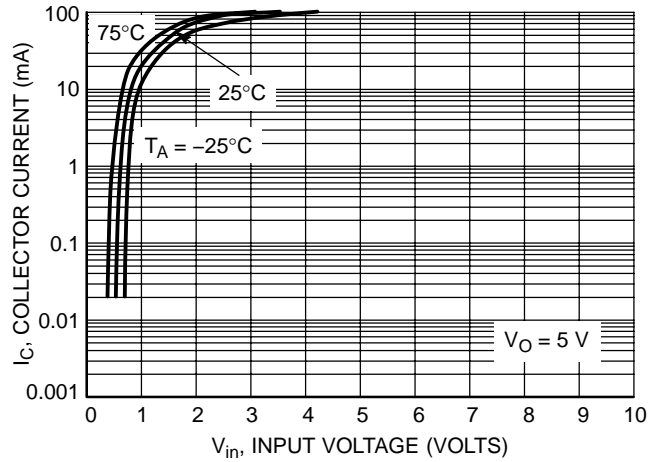


Figure 30. Output Current versus Input Voltage

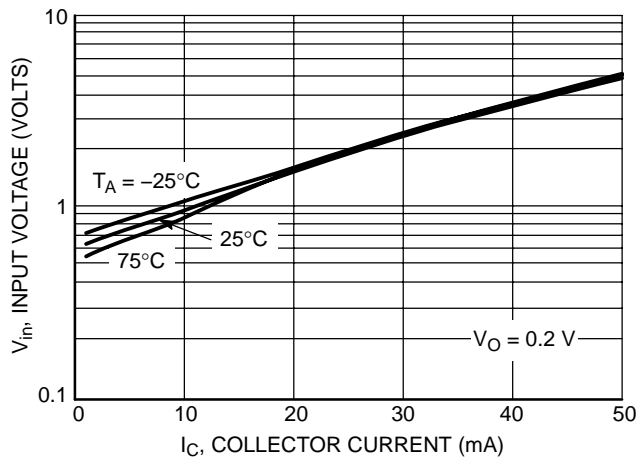


Figure 31. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5230DW1T1

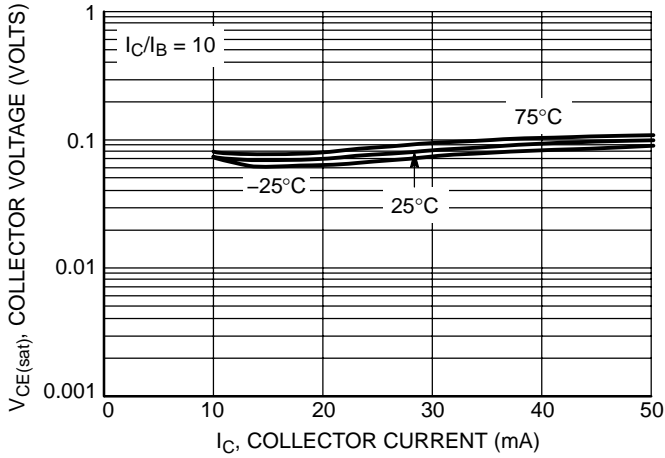


Figure 32.  $V_{CE(sat)}$  versus  $I_C$

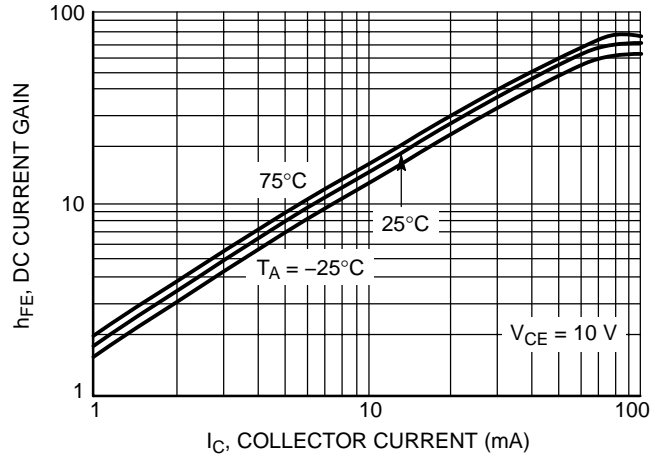


Figure 33. DC Current Gain

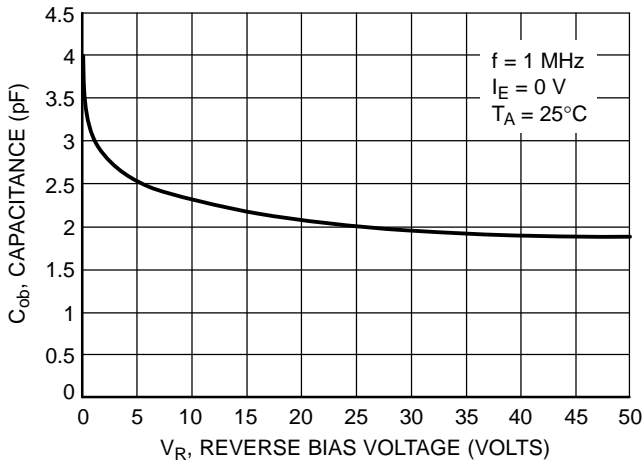


Figure 34. Output Capacitance

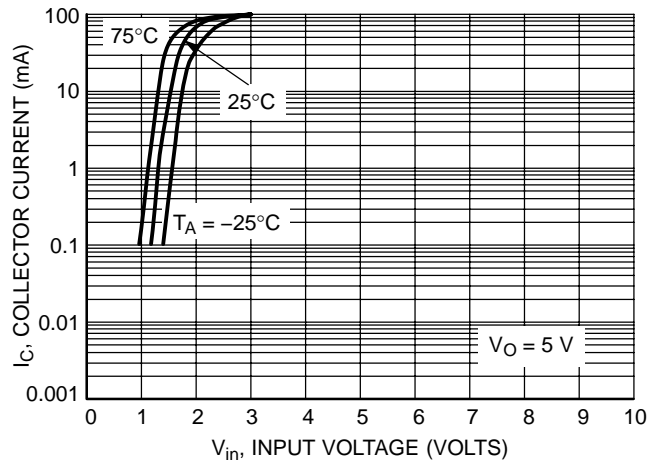


Figure 35. Output Current versus Input Voltage

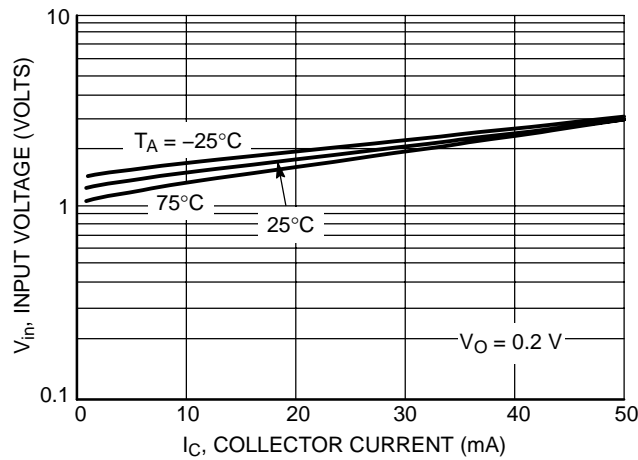


Figure 36. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5231DW1T1

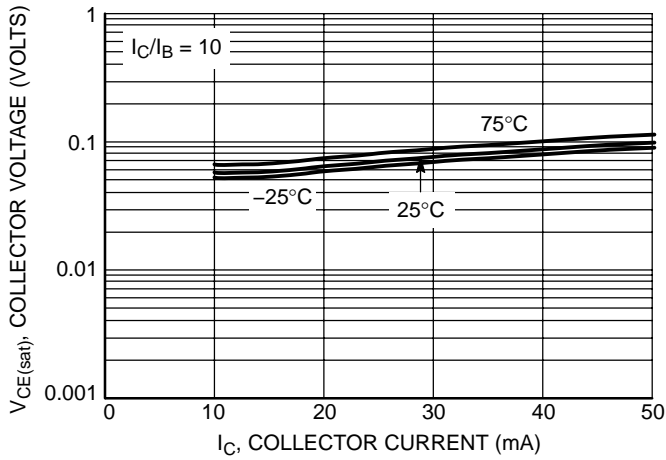


Figure 37.  $V_{CE(sat)}$  versus  $I_C$

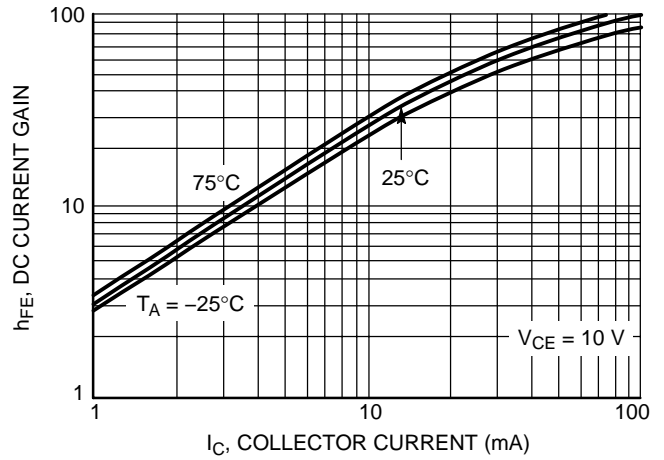


Figure 38. DC Current Gain

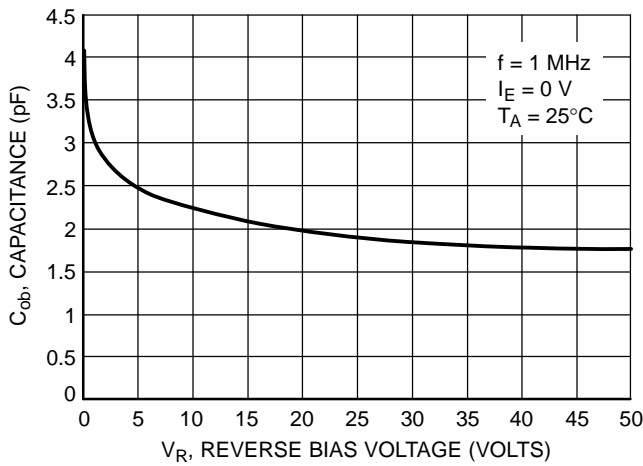


Figure 39. Output Capacitance

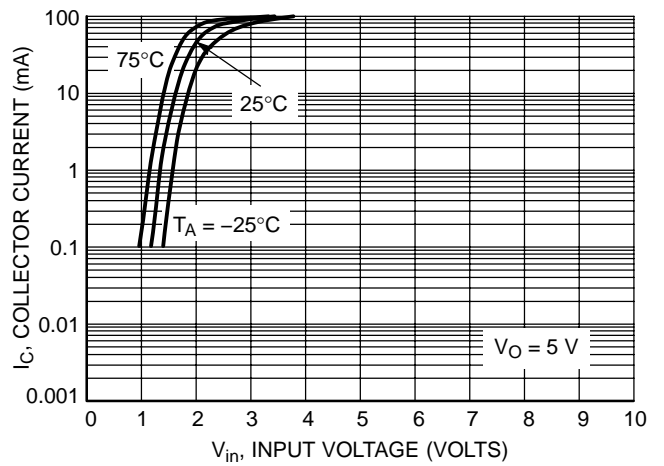


Figure 40. Output Current versus Input Voltage

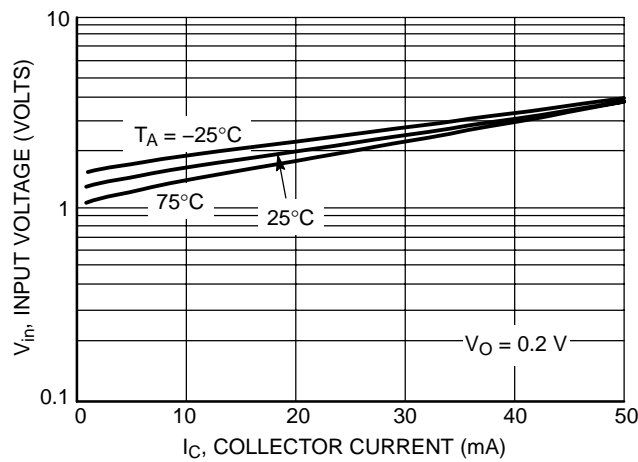


Figure 41. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5232DW1T1

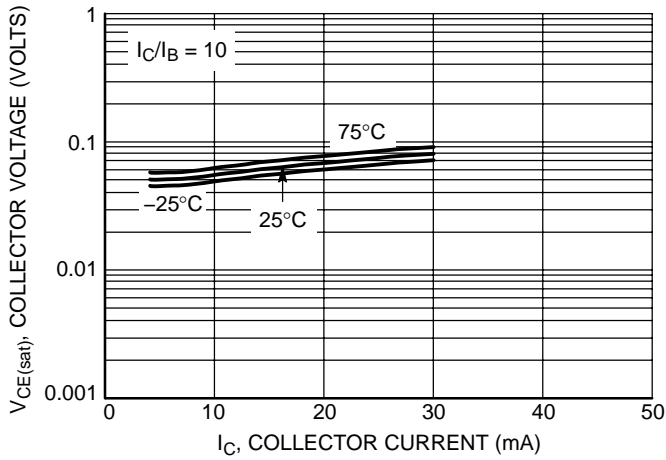


Figure 42.  $V_{CE(sat)}$  versus  $I_C$

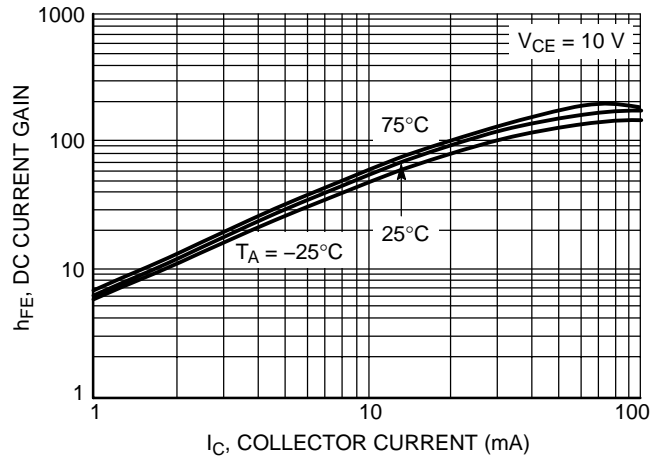


Figure 43. DC Current Gain

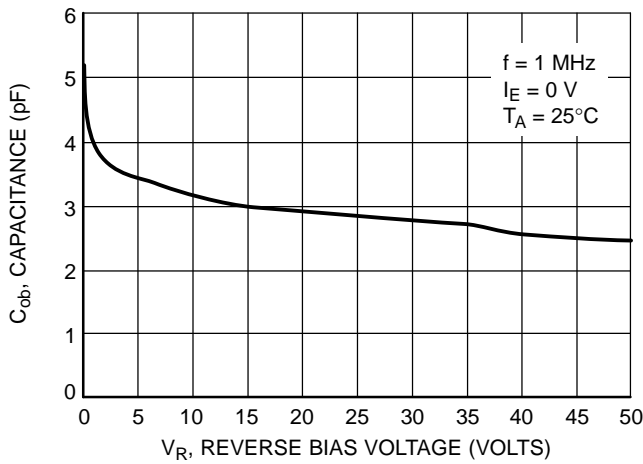


Figure 44. Output Capacitance

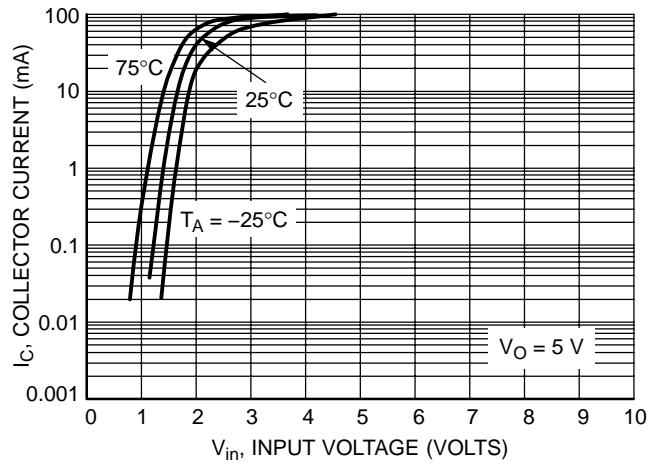


Figure 45. Output Current versus Input Voltage

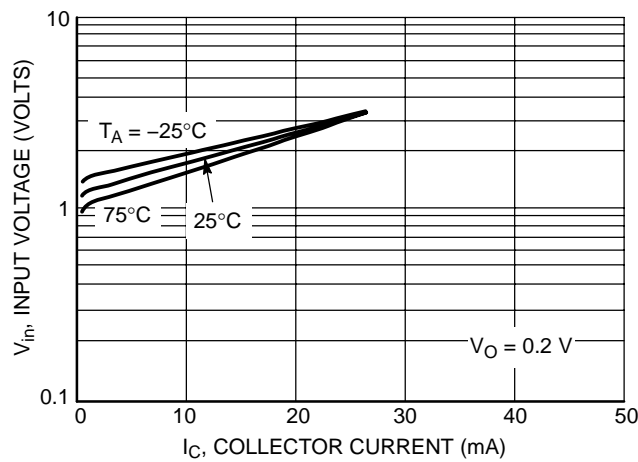


Figure 46. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5233DW1T1

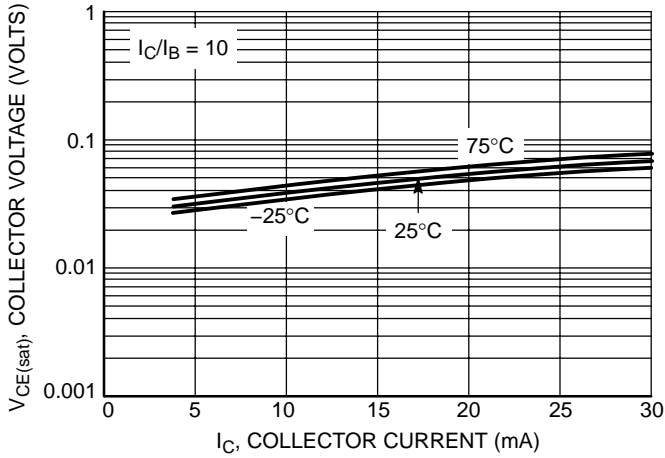


Figure 47.  $V_{CE(sat)}$  versus  $I_C$

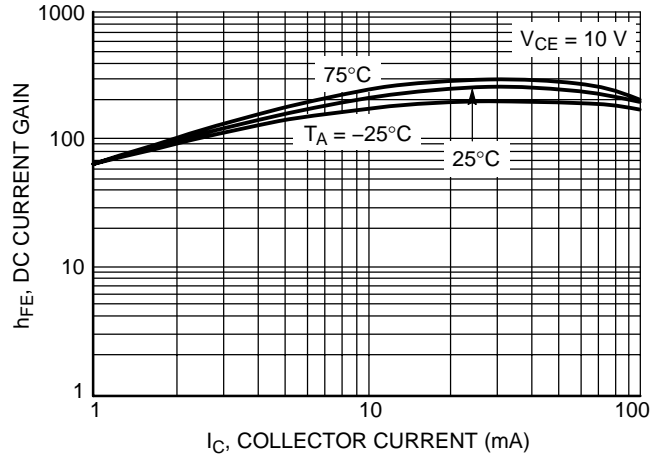


Figure 48. DC Current Gain

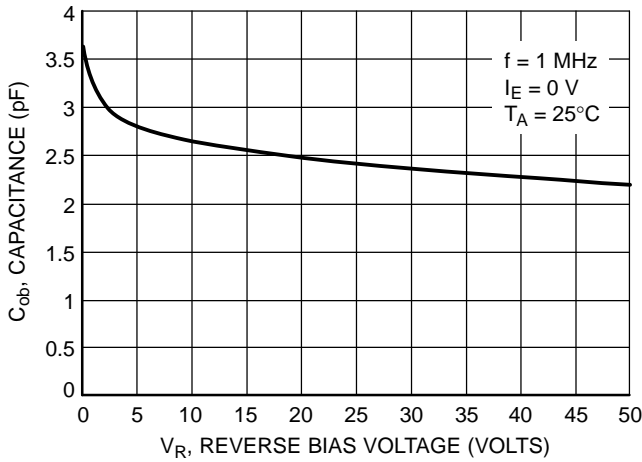


Figure 49. Output Capacitance

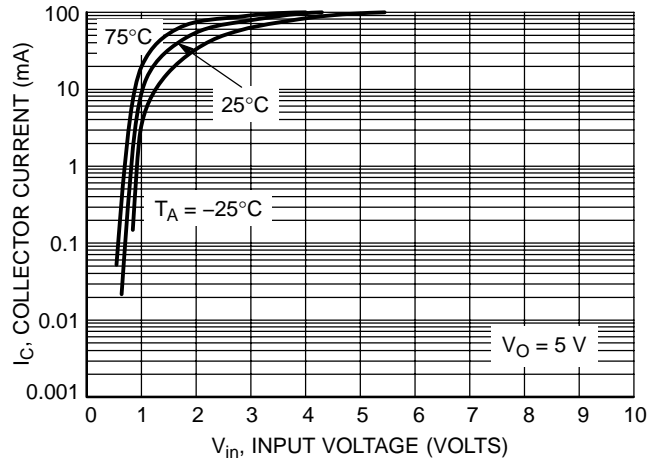


Figure 50. Output Current versus Input Voltage

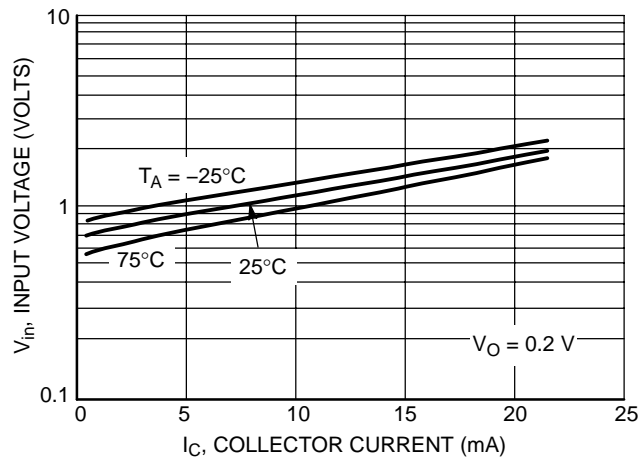


Figure 51. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5234DW1T1

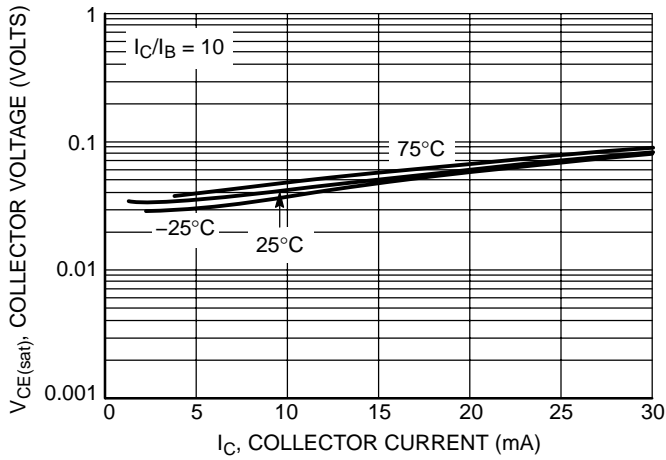


Figure 52.  $V_{CE(sat)}$  versus  $I_C$

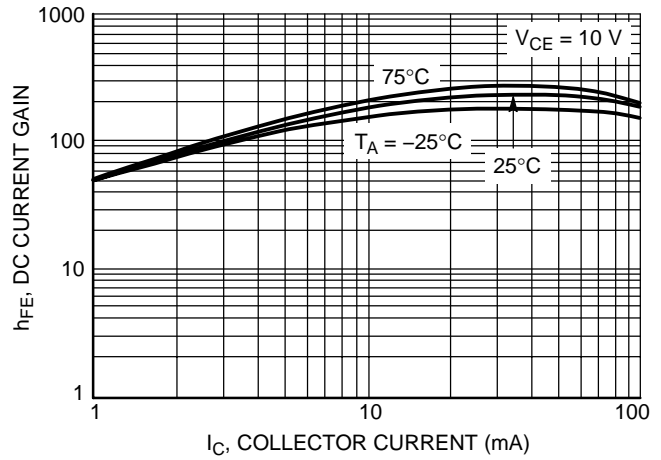


Figure 53. DC Current Gain



Figure 54. Output Capacitance

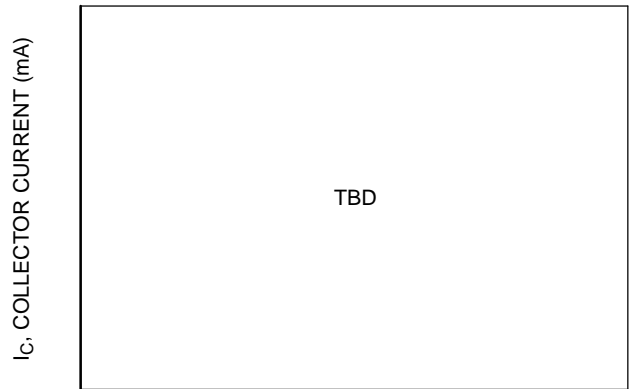


Figure 55. Output Current versus Input Voltage

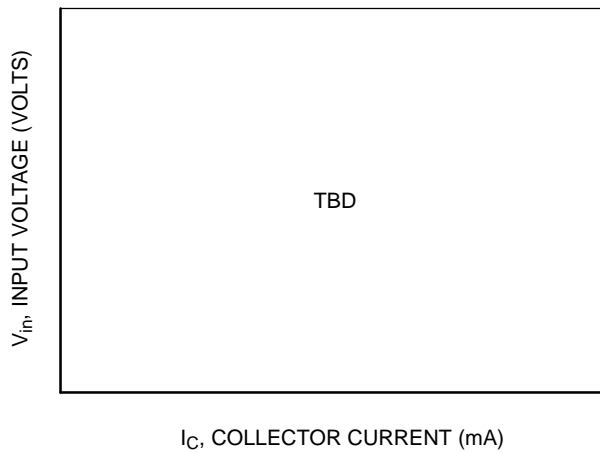


Figure 56. Input Voltage versus Output Current



# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5235DW1T1

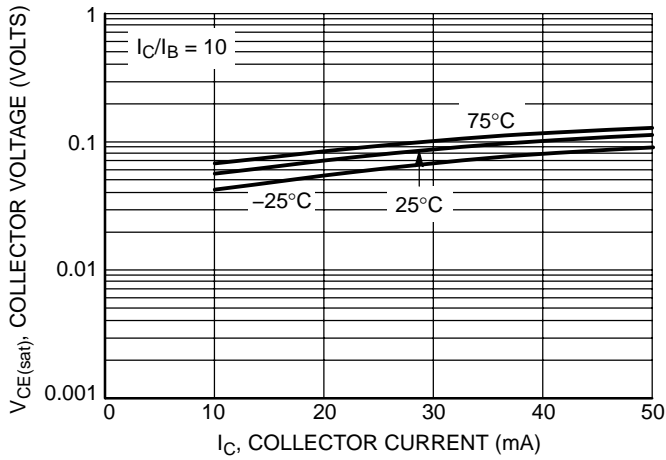


Figure 57.  $V_{CE(sat)}$  versus  $I_C$

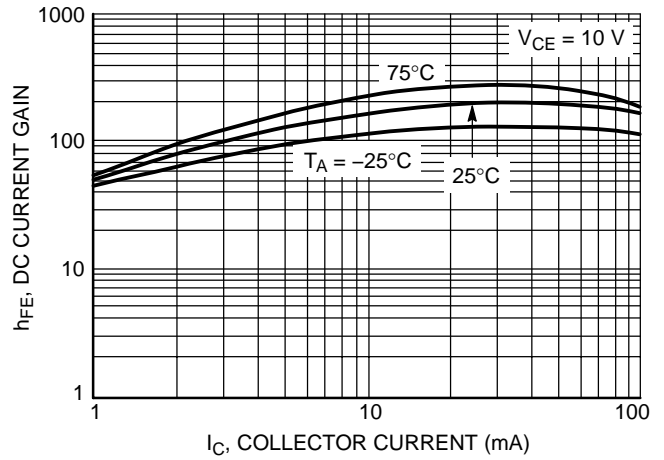


Figure 58. DC Current Gain

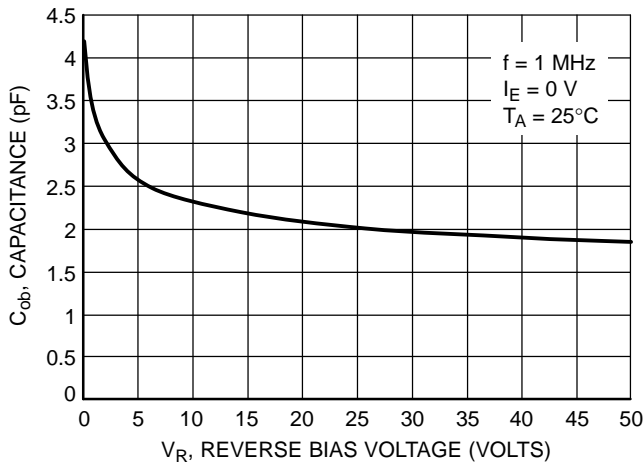


Figure 59. Output Capacitance

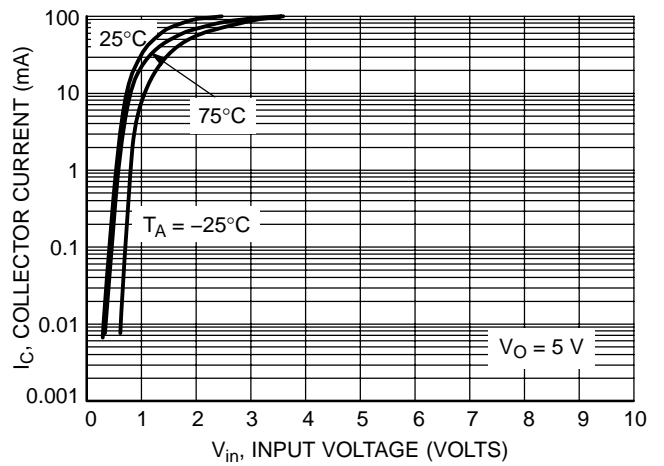


Figure 60. Output Current versus Input Voltage

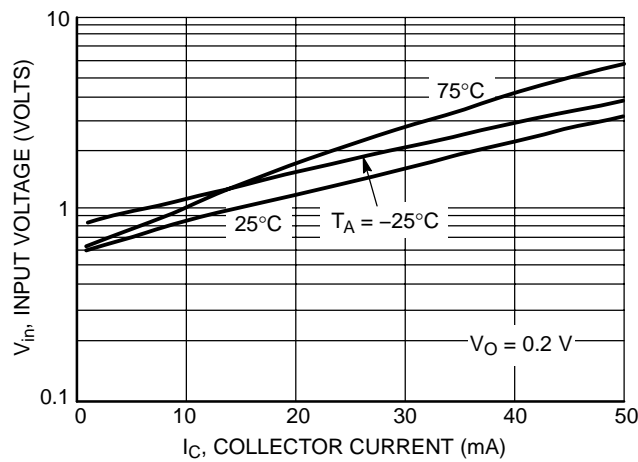


Figure 61. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5236DW1T1

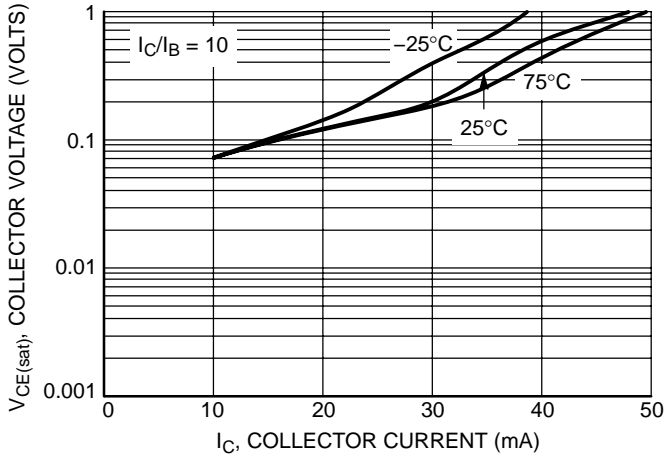


Figure 62.  $V_{CE(sat)}$  versus  $I_C$

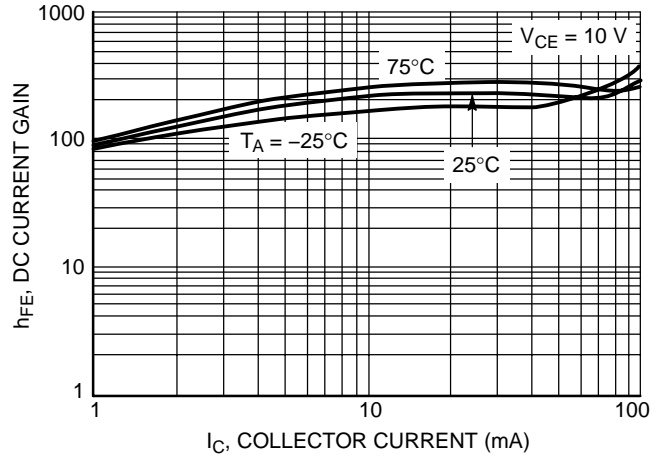


Figure 63. DC Current Gain

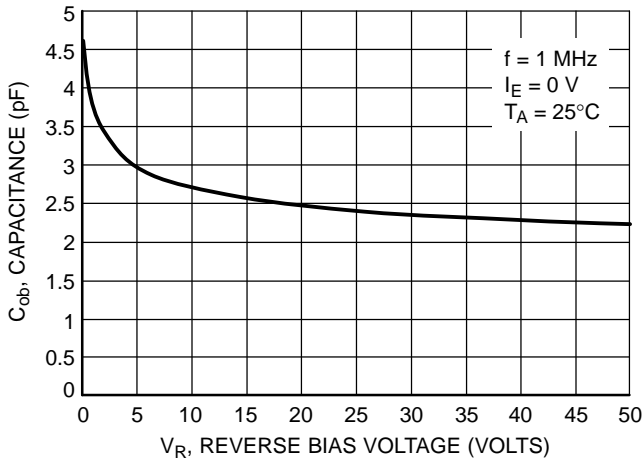


Figure 64. Output Capacitance

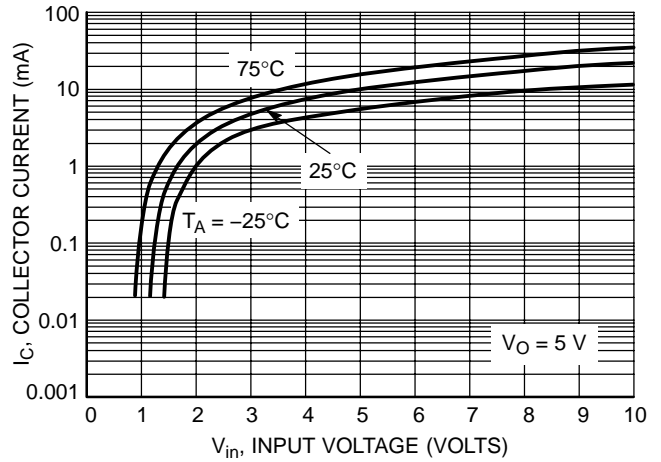


Figure 65. Output Current versus Input Voltage

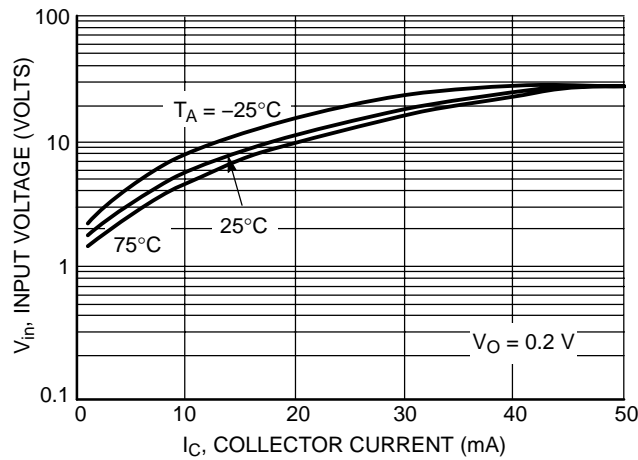


Figure 66. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## TYPICAL ELECTRICAL CHARACTERISTICS — MUN5237DW1T1

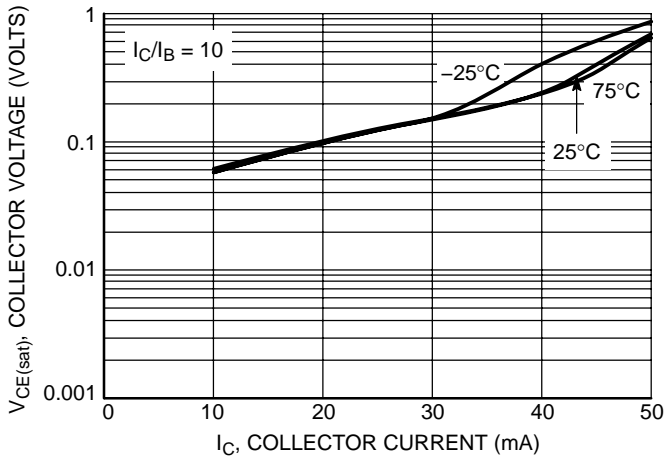


Figure 67.  $V_{CE(sat)}$  versus  $I_C$

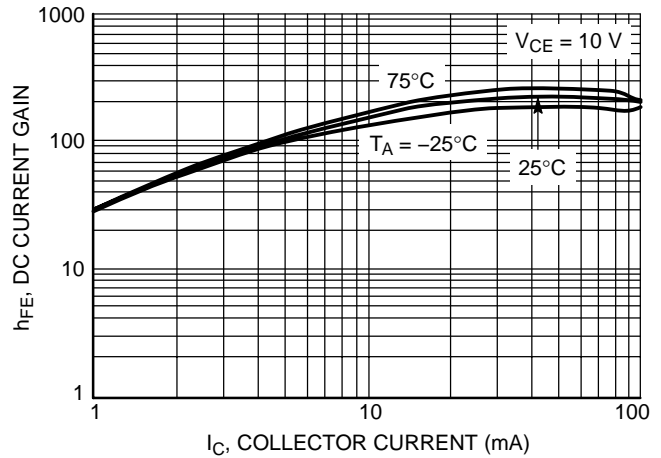


Figure 68. DC Current Gain

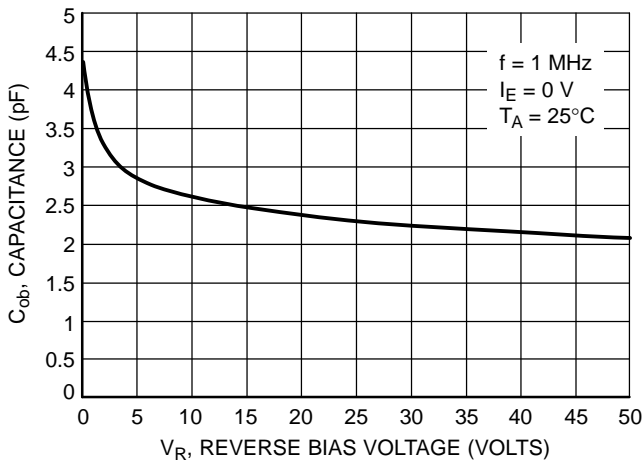


Figure 69. Output Capacitance

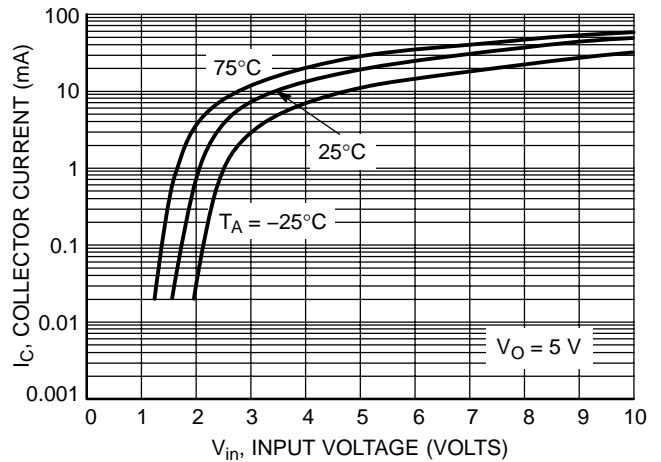


Figure 70. Output Current versus Input Voltage

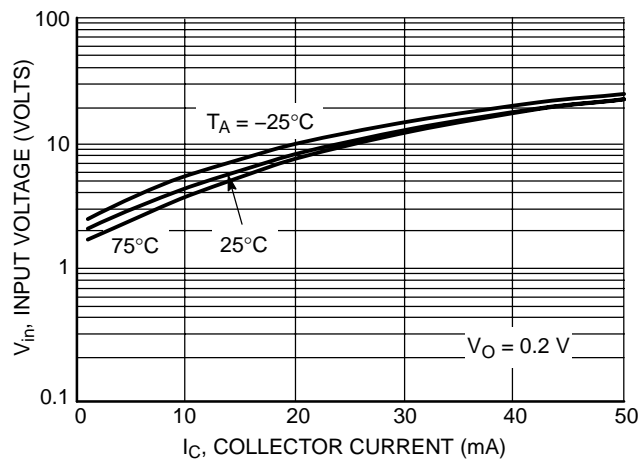
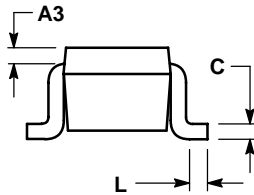
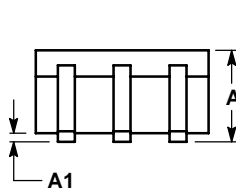
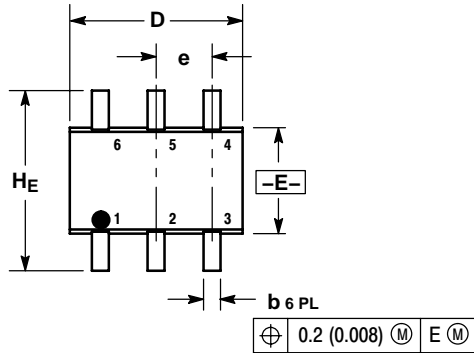


Figure 71. Input Voltage versus Output Current

# MUN5211DW1T1 Series

## PACKAGE DIMENSIONS

SC-88 (SOT-363)  
CASE 419B-02  
ISSUE V



NOTES:

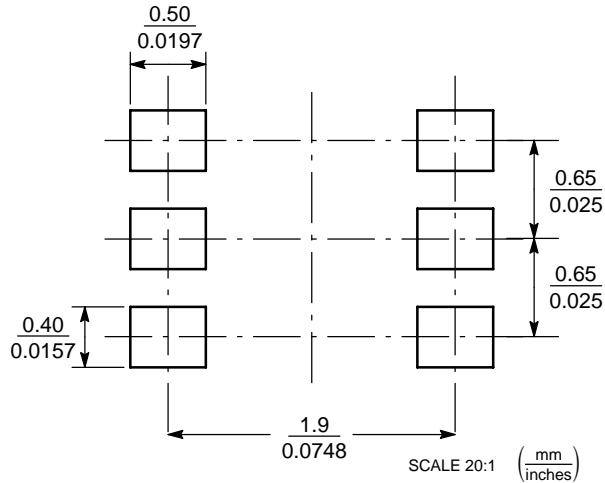
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
C	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086

STYLE 1:

- PIN 1. EMITTER 2
2. BASE 2
3. COLLECTOR 1
4. EMITTER 1
5. BASE 1
6. COLLECTOR 2

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MUN5211DW1T1 Series

**ON Semiconductor** and **ON** are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
P.O. Box 61312, Phoenix, Arizona 85082-1312 USA  
**Phone:** 480-829-7710 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 480-829-7709 or 800-344-3867 Toll Free USA/Canada  
**Email:** [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada

**Japan:** ON Semiconductor, Japan Customer Focus Center  
2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051  
**Phone:** 81-3-5773-3850

**ON Semiconductor Website:** <http://onsemi.com>

**Order Literature:** <http://www.onsemi.com/litorder>

For additional information, please contact your  
local Sales Representative.

**MUN5211DW1T1/D**